



ILD: a Detector for the International Linear Collider

A. Irlles on behalf of the ILD concept group*

TIPP2021 - 25th May 2021

** AITANA group at IFIC - CSIC/UV*



The International Linear Collider

© Rey Hori

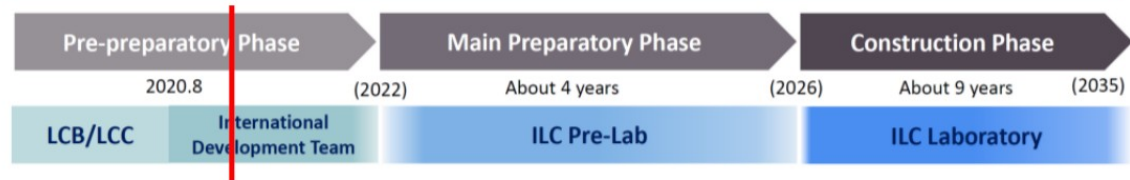


- ▶ Energy: Z-mass - 1 TeV
- ▶ Electron and positron polarisation
- ▶ TDR in 2013
 - + DBD for detectors
- ▶ Initial Energy 250 GeV – Footprint ~20km



Under discussion in Japanese Government and international community

International Development Team (IDT)

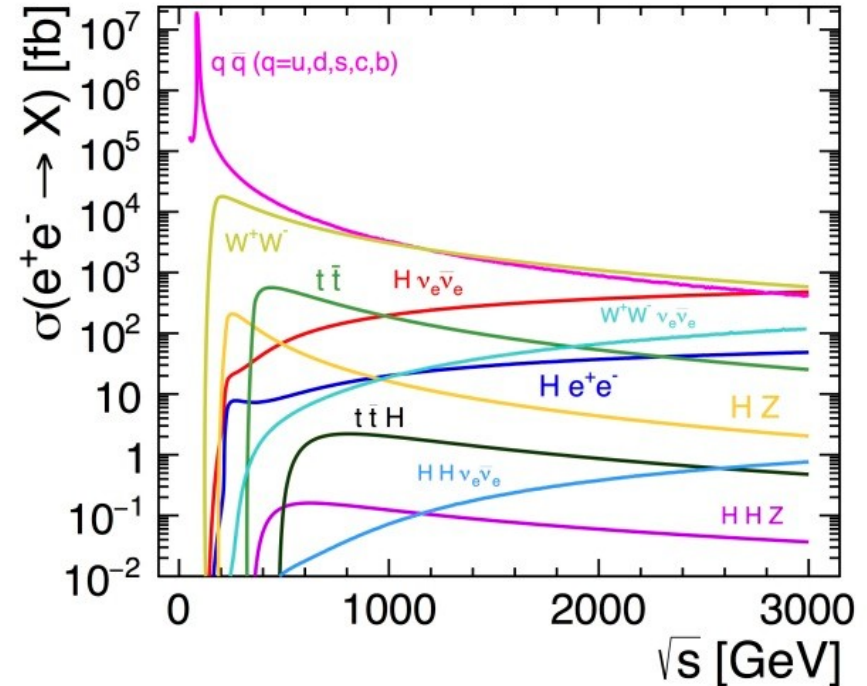


Higgs factory (and EW, and top-quark and...)

- ▶ All Standard Model particles within reach of the ILC project
- ▶ High precision tests of Standard Model over wide range to detect onset of New Physics
 - Machine settings can be “tailored” for specific processes → straightforward at the ILC
 - Centre-of-Mass energy
 - Beams polarisation ($\pm 80\% e^-$, $\pm 30\% e^+$)

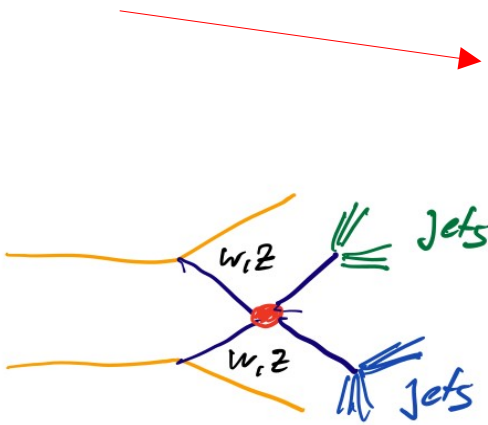
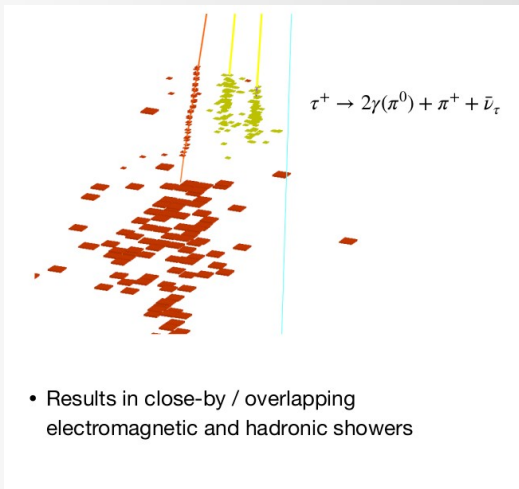
▶ Higgs factories but also...

- “light” qq factory
(and Z-factory at Z-pole)
- WW factory
- Top-quark factory
- ttH factory
- ...

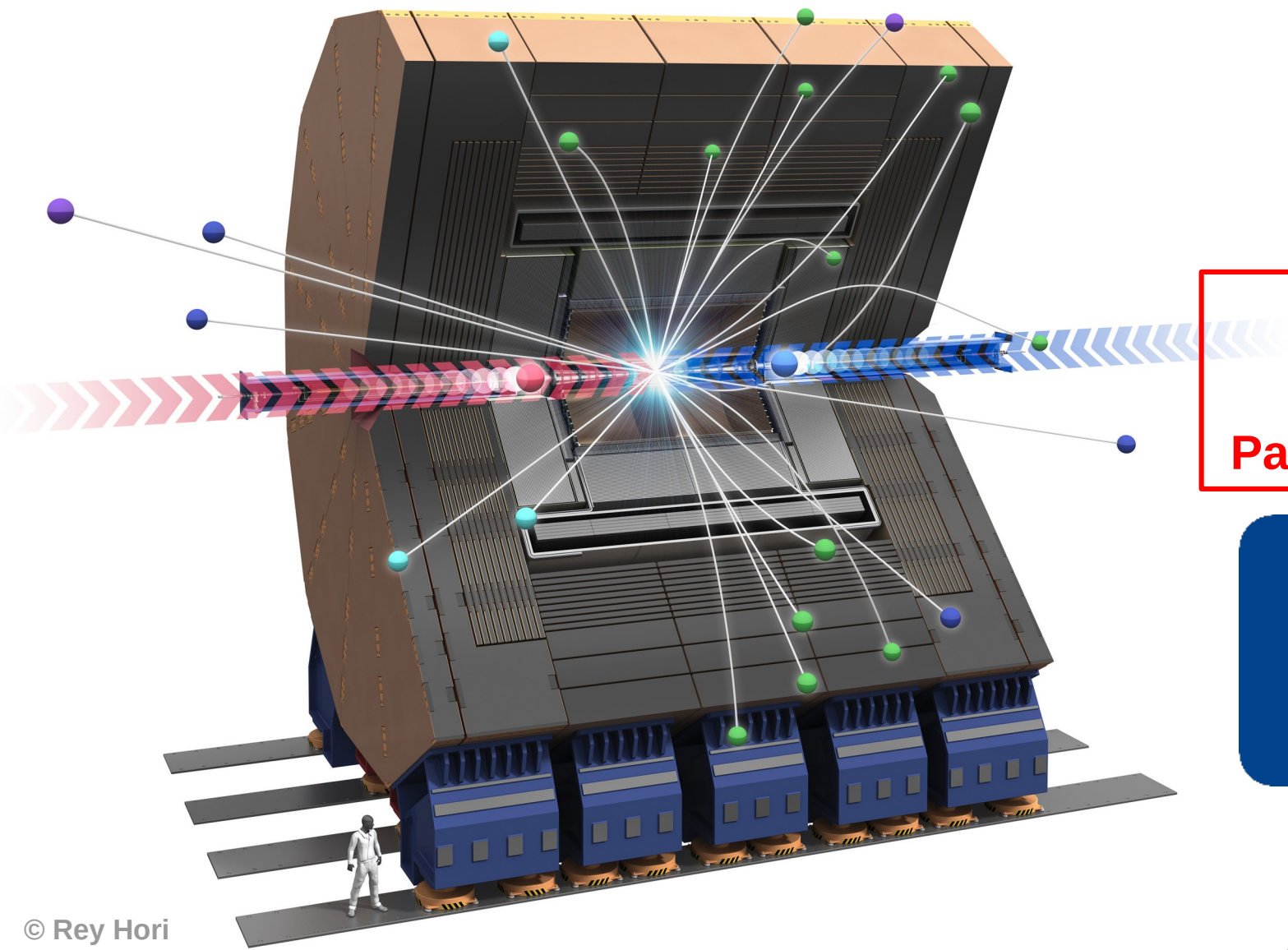


Detector Requirements

- ▶ A comprehensive test of the SM and BSM (specially in the Higgs sector) requires unprecedented performance of the detector and reconstruction techniques
- ▶ Excellent tracking + flavour tagging + Particle Identification
- ▶ Single particle separation
- ▶ Excellent energy resolution of ~3%

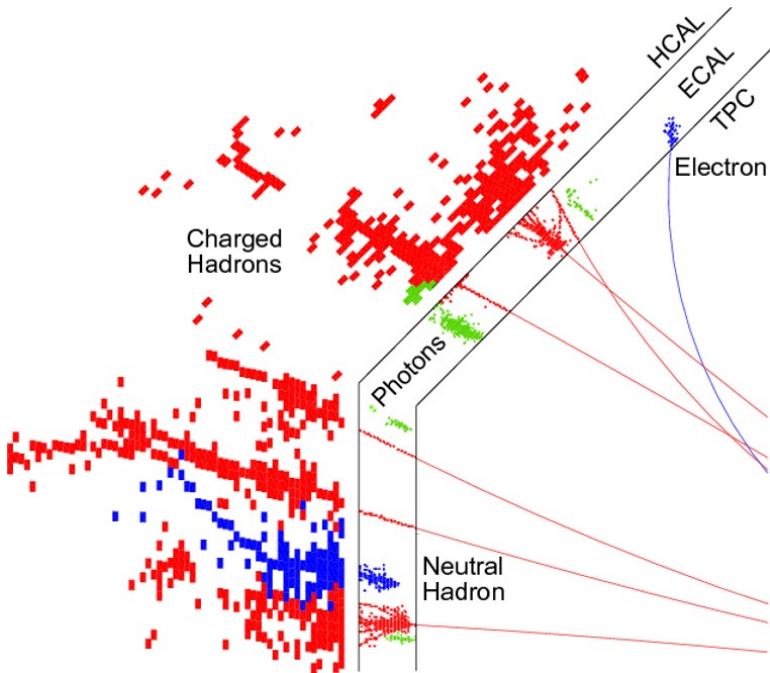


How ?
By designing a
Particle Flow Detector



How ?
By designing a
Particle Flow Detector





Concept

- ▶ Base the measurement on the subsystem with best resolution for a given particle type (and energy)
- ▶ Separation of signals by charge and neutral particles in the calorimeters
- ▶ **Single particle separation**

Technological Challenges

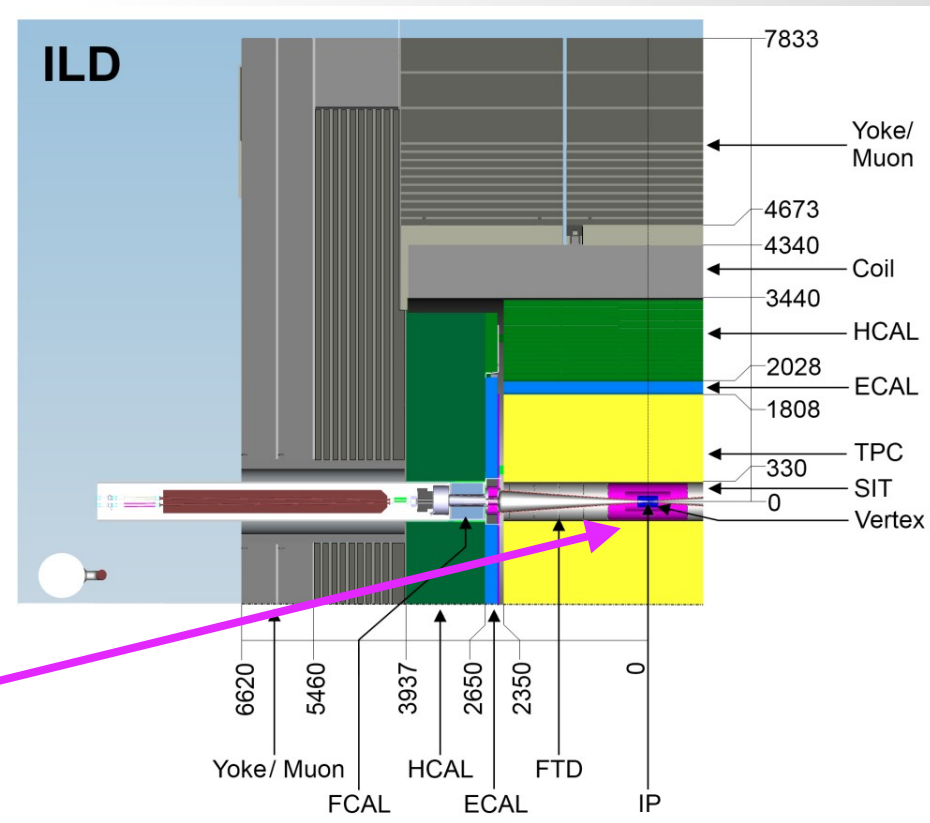
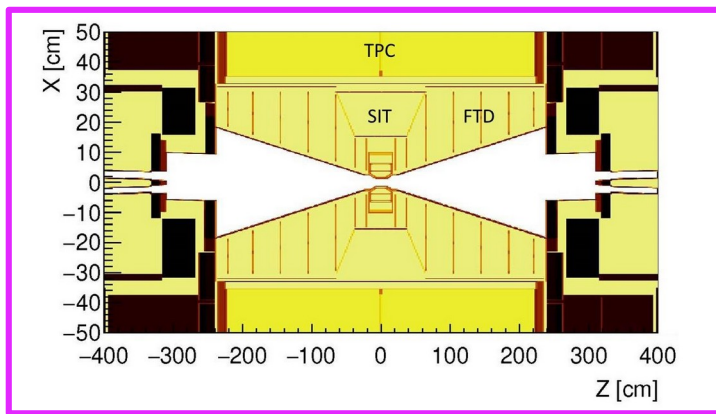
- ▶ Need **extremely granular calorimeters** (100 of millions of cells...!)
- ▶ Require **very low material budget** in front of the calorimeters and **excellent tracking systems**

Limitations

- ▶ Complicated topology by (hadronic) showers
- ▶ Overlap between showers compromises correct assignment of calorimeter hits → **Confusion term**
 - Need to minimize this term as much as possible

Main features of the ILD

- ▶ Particle flow as the key design driver
- ▶ Excellent vertexing very close to the IP
- ▶ Hybrid tracking system optimized for excellent resolution at high energies and ultimate efficiency over a broad momentum range
- ▶ High granular calorimetry
- ▶ Up to and including the HCAL, all inside solenoidal coil of 3-4 T



From key requirements from physics:

- **p_t resolution** (total ZH x-section)

$$\sigma(1/p_t) = 2 \times 10^{-5} \text{ GeV}^{-1} \oplus 1 \times 10^{-3} / (p_t \sin^{1/2}\theta)$$

≈ CMS / 40

- **vertexing** ($H \rightarrow bb/cc/\tau\tau$)

$$\sigma(d_0) < 5 \oplus 10 / (p[\text{GeV}] \sin^{3/2}\theta) \mu\text{m}$$

≈ CMS / 4

- **jet energy resolution** ($H \rightarrow \text{invisible}$) 3-4%

≈ ATLAS / 2

- **hermeticity** ($H \rightarrow \text{invis}$, BSM) $\theta_{\min} = 5 \text{ mrad}$

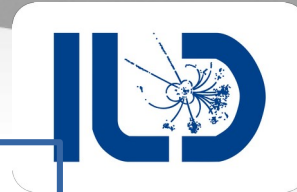
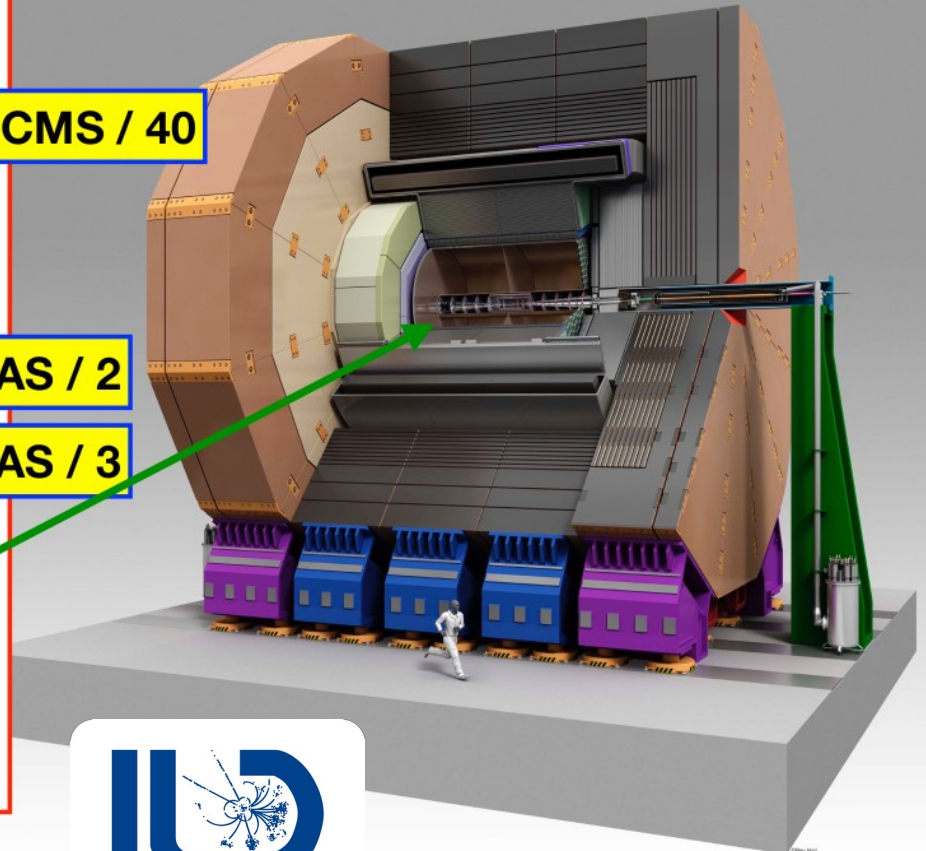
≈ ATLAS / 3

To key features of the detector:

- **low mass tracker:**

- main device: **Time Projection Chamber** (dE/dx !)
- add. silicon: eg VTX: 0.15% rad. length / layer)

- **high granularity calorimeters**
optimised for particle flow



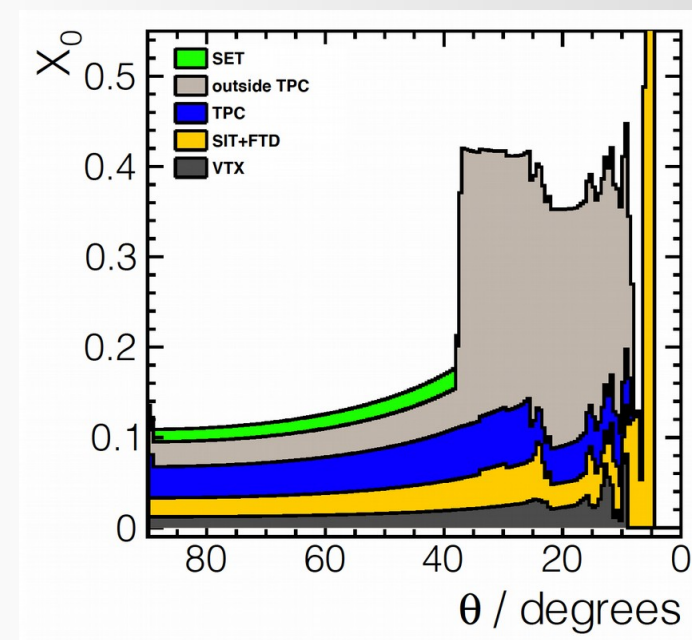
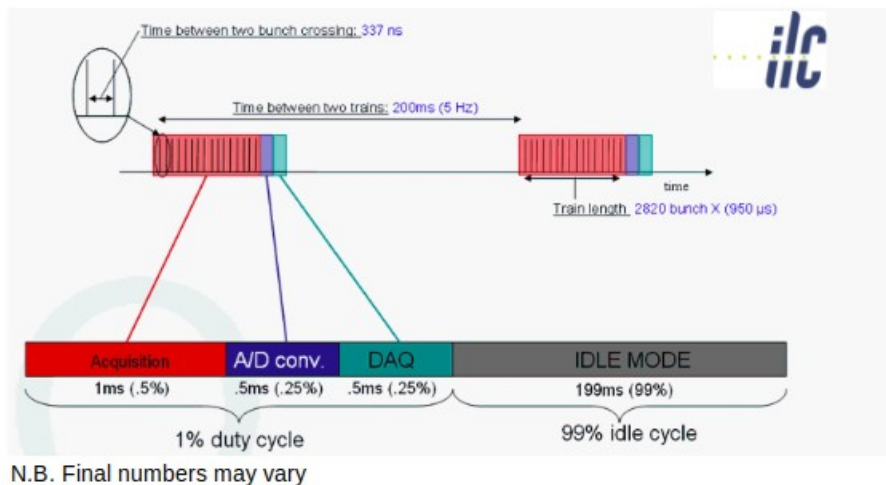
~x1000 more ro cells than LHC exps.
~x10-100 more than HL-LHC exps.



Linear Lepton Colliders favor fully optimized PFA detectors

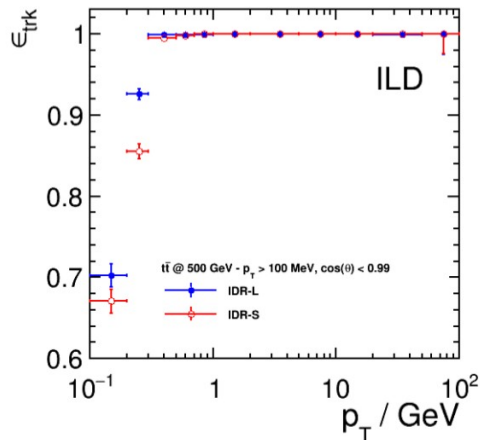
- ▶ Possible since experimental environment at ILC very different from LHC/LEP:
 - much smaller beam spot and beam pipe (first tracking layer at $\sim 1\text{cm}$ of the IP)
 - much lower backgrounds
 - much less radiation
 - **Pulsed beam structure**

Power pulsed electronics → *low material budget !*
triggerless operation ! → *ALL events are recorded*

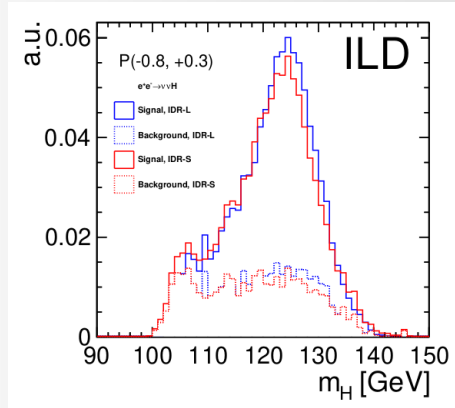
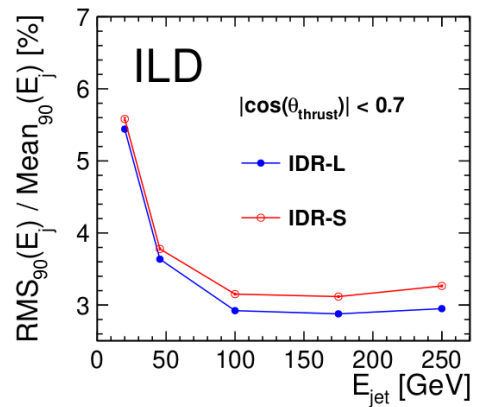


Different ILD models have been optimized to maximize the performance:
Full simulation & realistic reconstruction

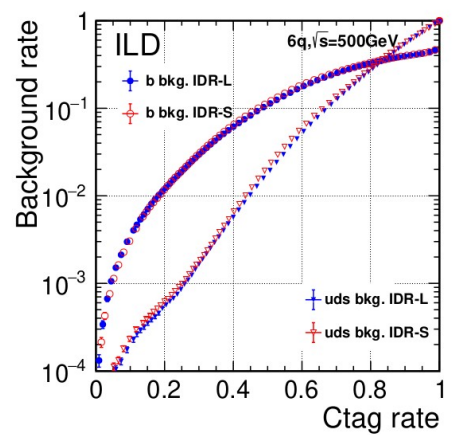
Tracking efficiency



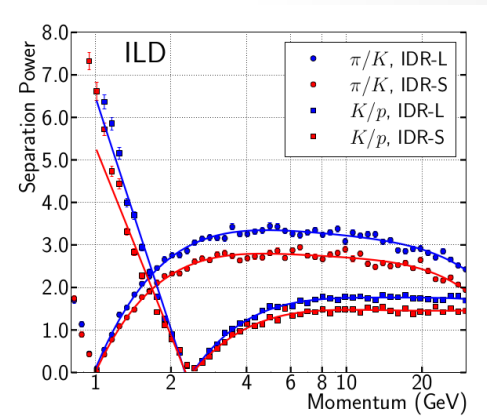
Jet Energy resolution



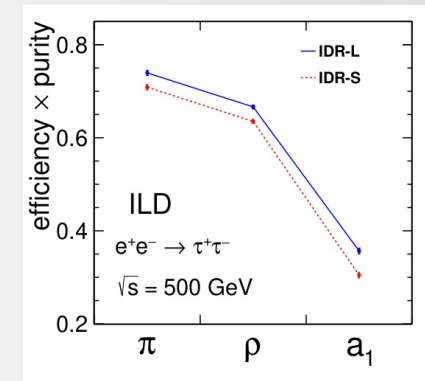
Flavour Tagging



Particle ID
 jet charge measurement



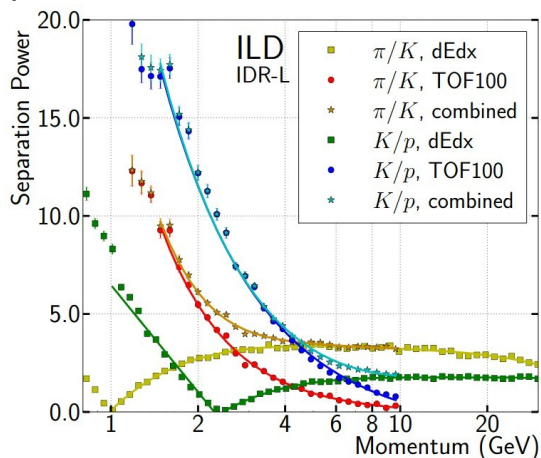
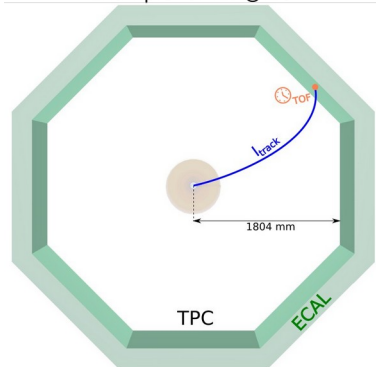
Tau Decay ID



TOF in the ECAL – Particle ID

- ▶ “Standard” silicon sensors could reach O(100-300ps)
- ▶ LGAD sensors could get us to O(10ps) Drawback: high power consumption.

Example for ILD@ILC

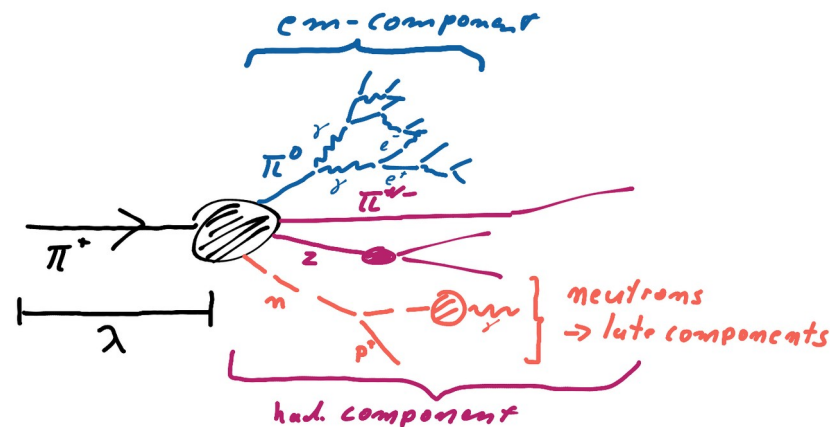


Impact in the physics reach?

- ▶ Could be a game changer for s-quark measurements
- $Z/\gamma/Z' \rightarrow s\bar{s}$ or $H \rightarrow s\bar{s}$

Timing measurements for shower developments

- ▶ Neutral and slow components
 - Require ~ns precision
 - Reachable today with “standard” silicon, scintillators calorimeters
- ▶ ~0.1 ns scale: near the corner
- ▶ An even lower with GRPC (20ps)

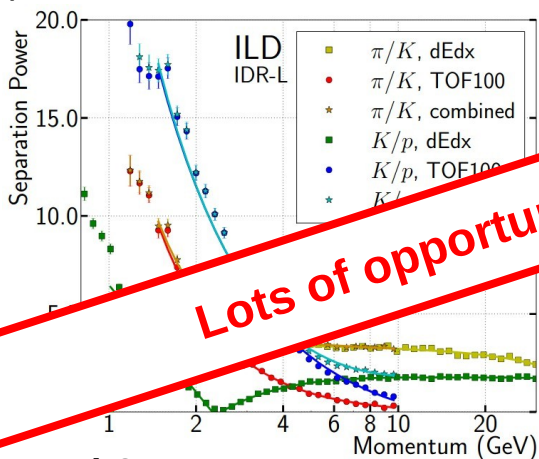
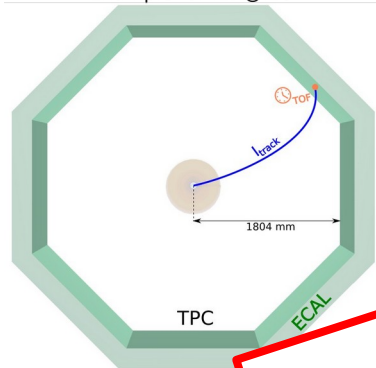


The ILD performance: timing ?

TOF in the ECAL – Particle ID

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Example for ILD@ILC



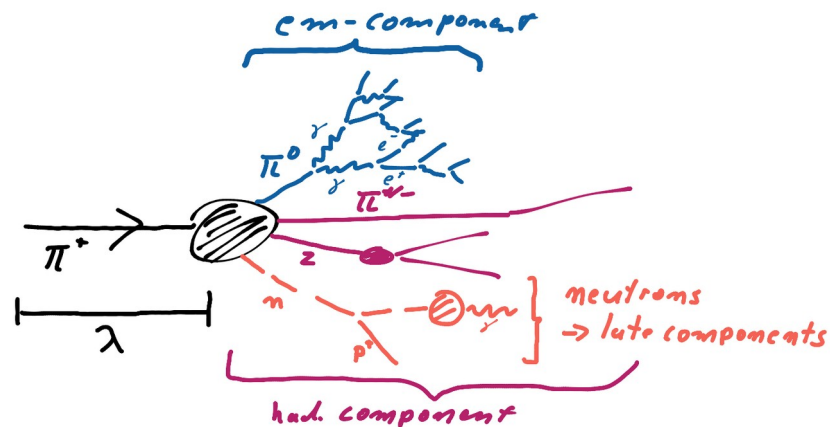
Lots of opportunities in this field

Impact in the physics reach?

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Timing measurements for shower developments

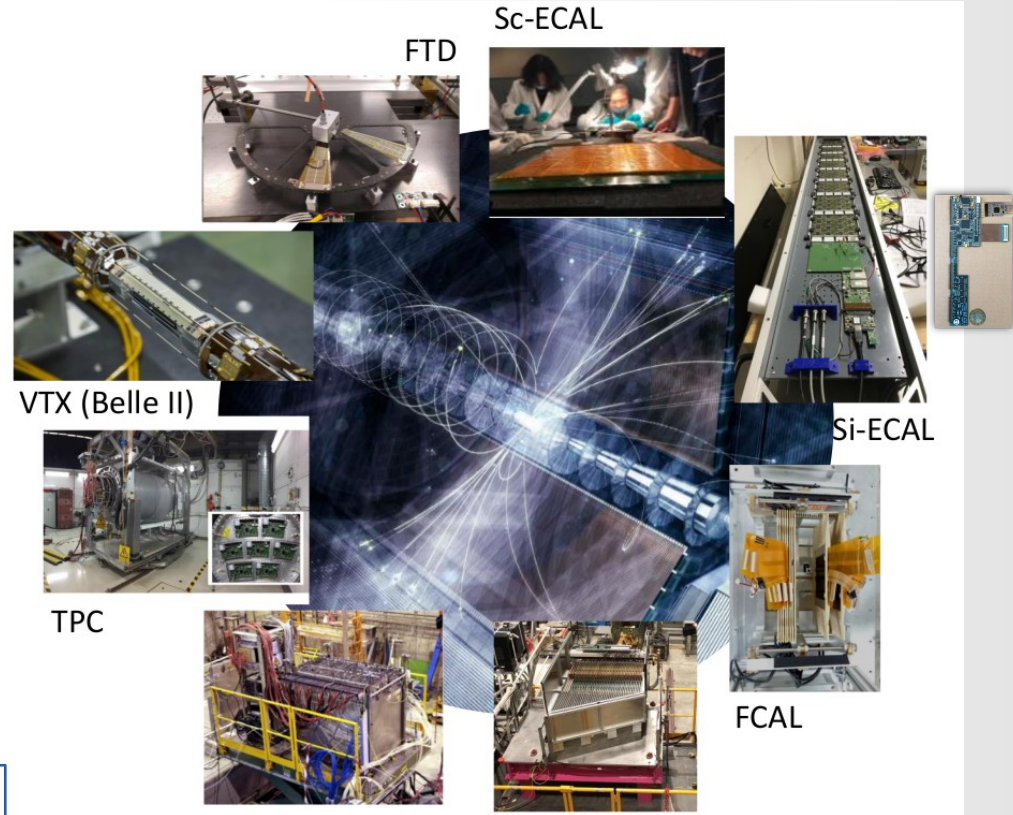
- ▶ Neutral and slow components
 - Require ~ns precision
 - Reachable today with “standard” silicon, scintillators calorimeters
- ▶ ~0.1 ns resolution at the corner
- ▶ Power with GRPC (20ps)



R&D status

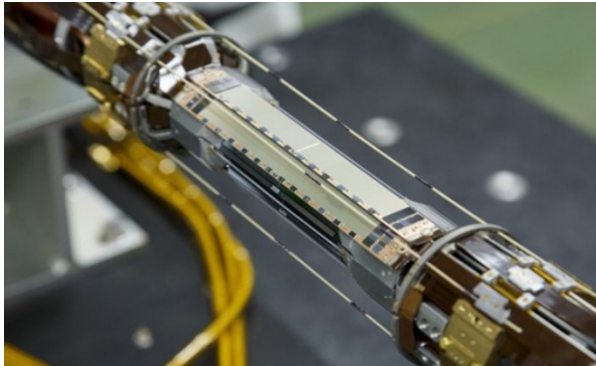
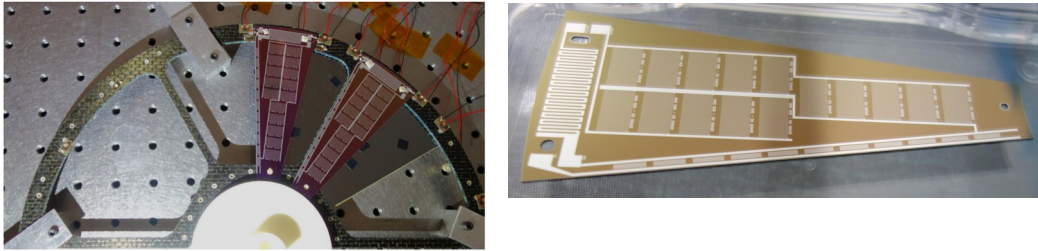
- ▶ ILD has a concept of the detector,
 - well defined
 - with technological options where sensible
- ▶ The main components of ILD
 - have been validated and beam-tested.
- ▶ A coherent System design has been developed.

Application of our technologies: CMS Calo upgrade, Belle VTX, T2K TPC, ALICE TPC



Slide borrowed from T. Benhke (ILD spokesperson)

Forward Tracking Petal Thermomechanical mock-up



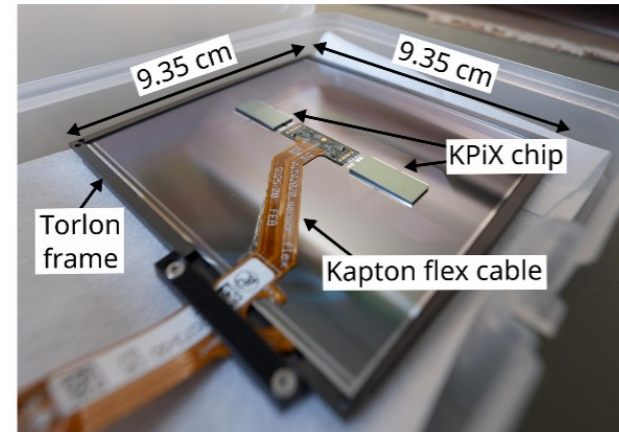
DEPFET VXD @ Belle2

▶ Silicon tracking conceptual studies

- VTX extensive technology studies

▶ Several technology options remain open

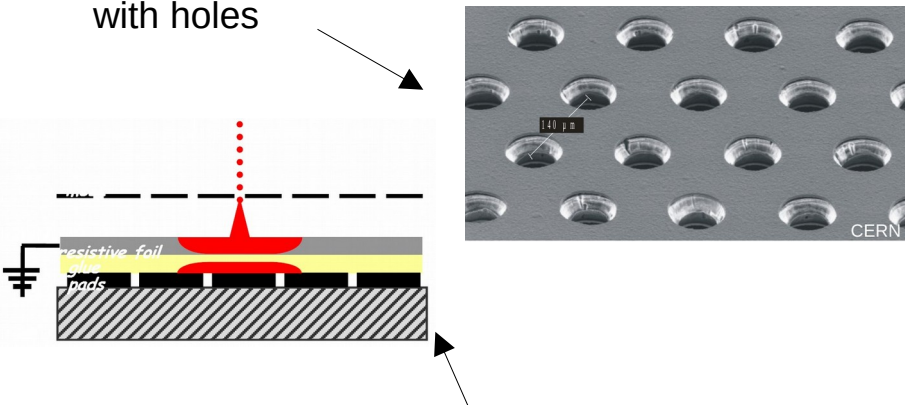
- CMOS / FPCCD / DEPFET / 3D-integrated / SOI



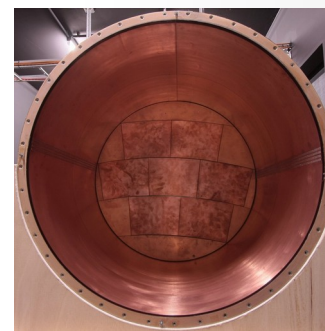
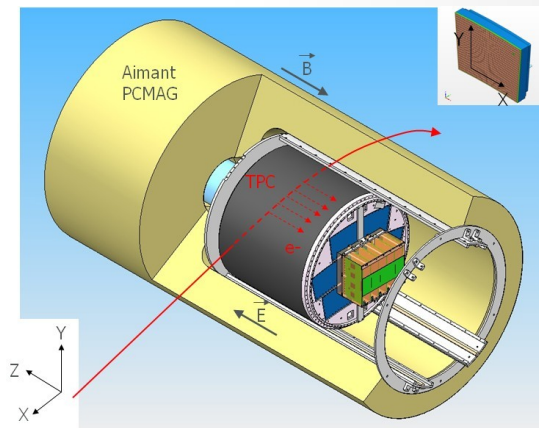
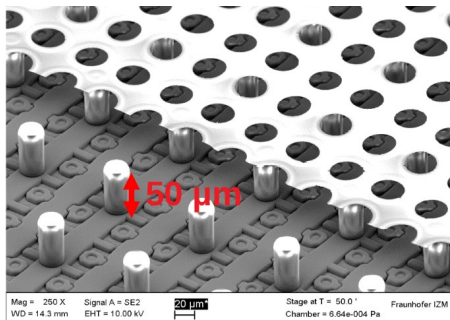
microstrip sensor

TPC Tracking System: R&D status

- ▶ Three baseline technologies
- ▶ **GEMs**: copper-insulator- copper sandwich, with holes



- ▶ Resistive Micromegas:
- ▶ GridPix

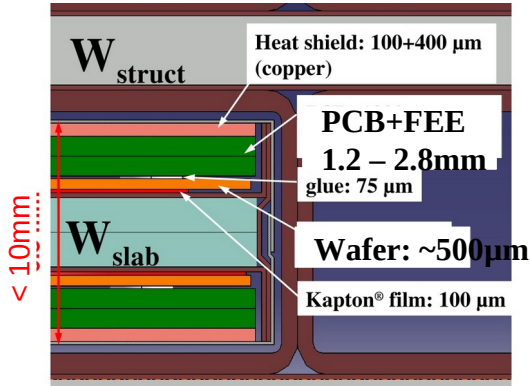


PCMAG: $B < 1.2$ T,
bore diameter: 85 cm
Electron test beam: $E = 1 - 6$ GeV



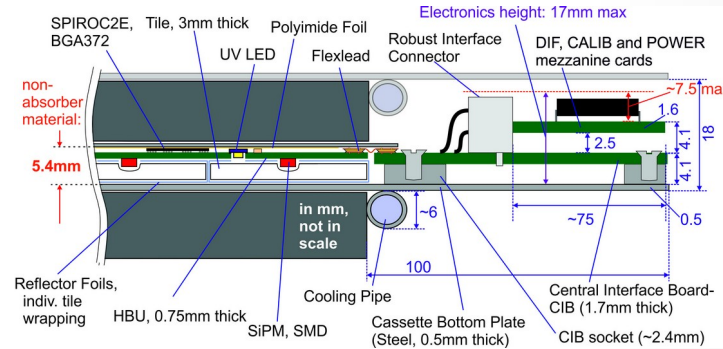
Large Prototype has been built to compare different detector readouts under identical conditions and to address integration issues

SiW Ecal



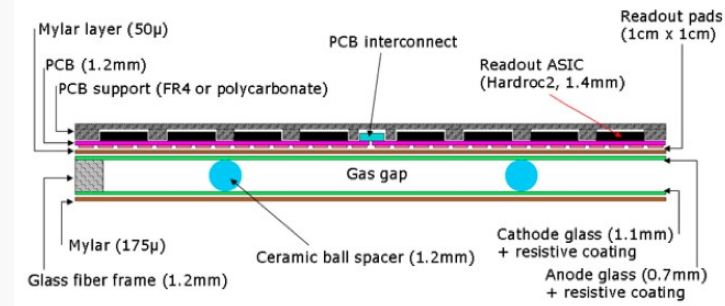
Semi-conductor readout
Typical segmentation: $0.5 \times 0.5 \text{ cm}^2$

Analogue Scintillator HCAL and ECAL



Optical readout
Typical segmentation: $3 \times 3 \text{ cm}^2$

Semi Digital HCAL



Gaseous readout
Typical segmentation: $1 \times 1 \text{ cm}^2$

Integrated front end electronics

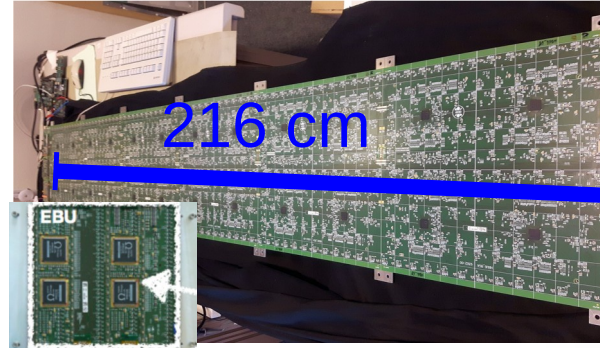
No drawback for precision measurements *NIM A 654 (2011) 97*

SiW Ecal



Semi-conductor readout

Analogue Hcal and Scintillator Ecal



Optical readout

Semi-digital Hcal



- **Realistic detector dimensions**
 - Structures of up to 3m in length (more than 10000 cells)
 - With compact external components
- Challenge for the power pulsing techniques (for the power consumption management)



SiW Ecal



Semi-conductor readout

Analogue Hcal and Scintillator Ecal

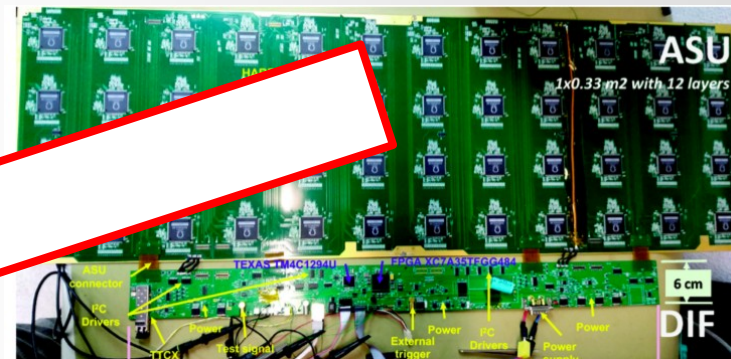


216 cm

VERY LONG DETECTORS

Optical readout

Semi-digital Hcal



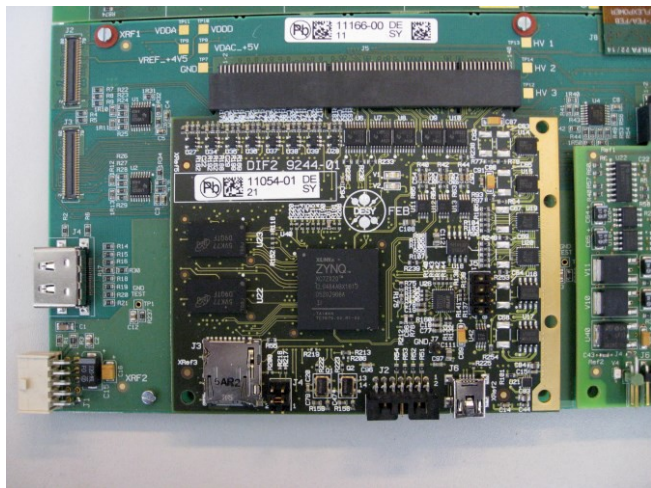
ASIC detector dimensions

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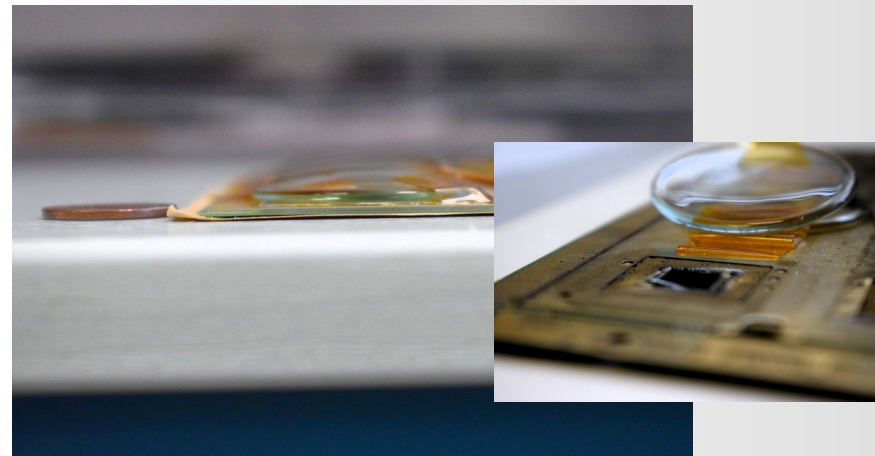
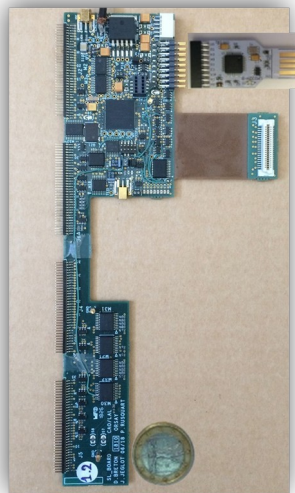


HG Calorimetry: Technological solutions III

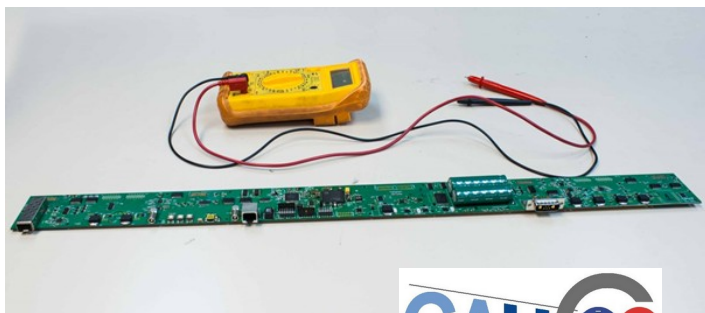
Current detector interface card - AHCAL



Current detector interface card and thin detection unit – SiW Ecal



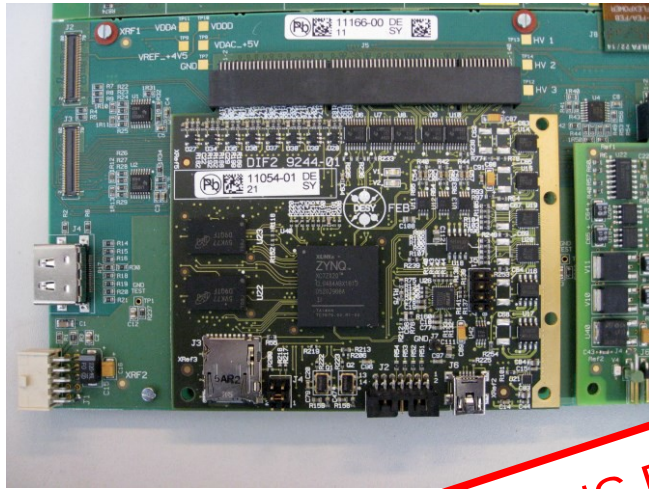
Current detector interface card - SDHCAL



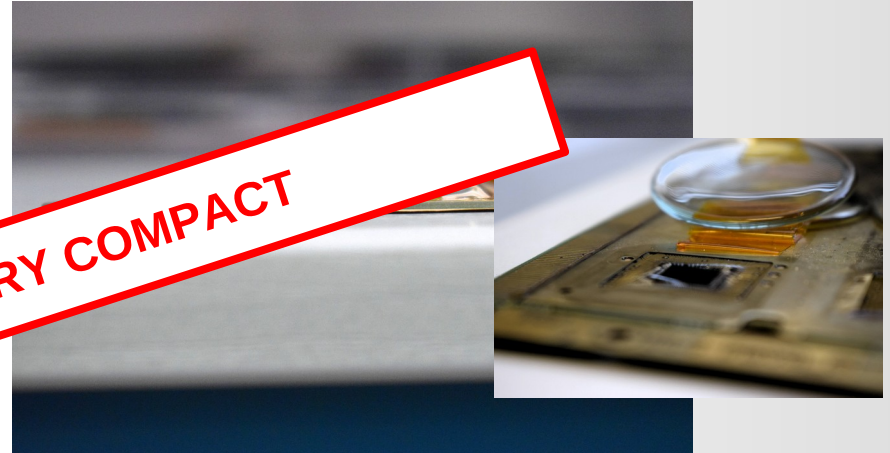
- “dead space free” granular calorimeters put **tight demands on compactness**
- Current developments within **CALICE meet these requirements**
 - Unique successes in worldwide detector R&D*
- Can be applied/adapted wherever compactness is mandatory
- Components will/did already go through scrutiny phase in beam test

HG Calorimetry: Technological solutions III

Current detector interface card - AHCAL

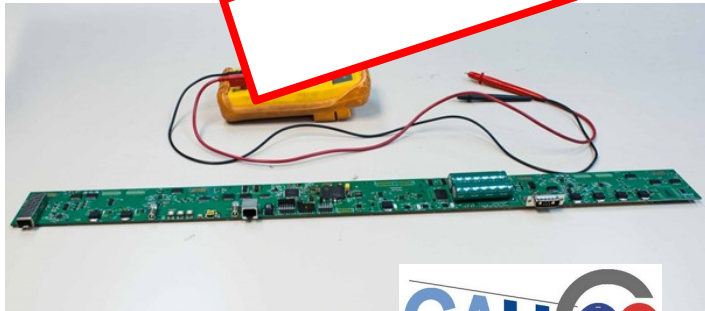


Current detector interface card and thin detection unit – SiW Ecal



LONG DETECTORS but VERY COMPACT

Current detector interface card - AHCAL

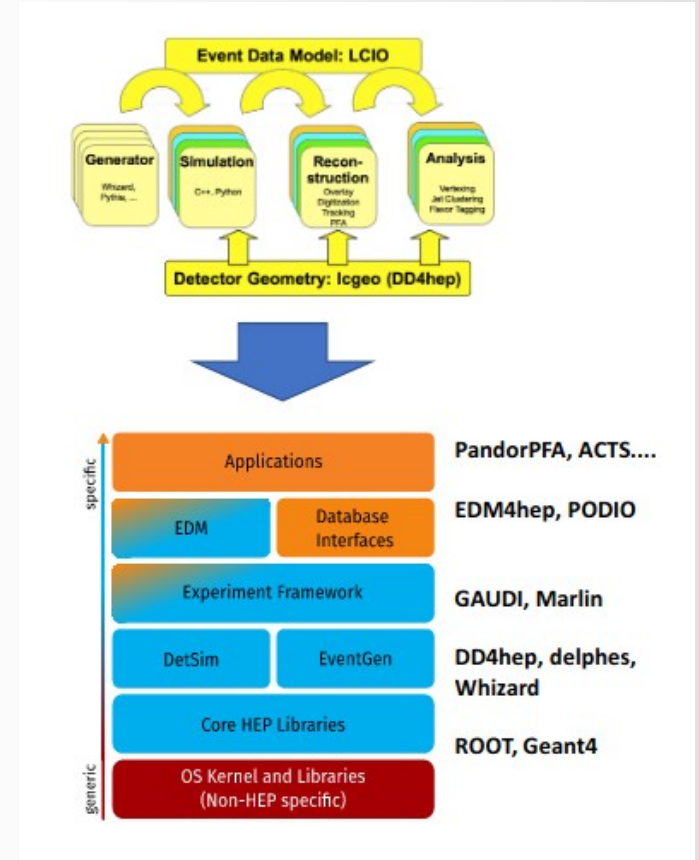
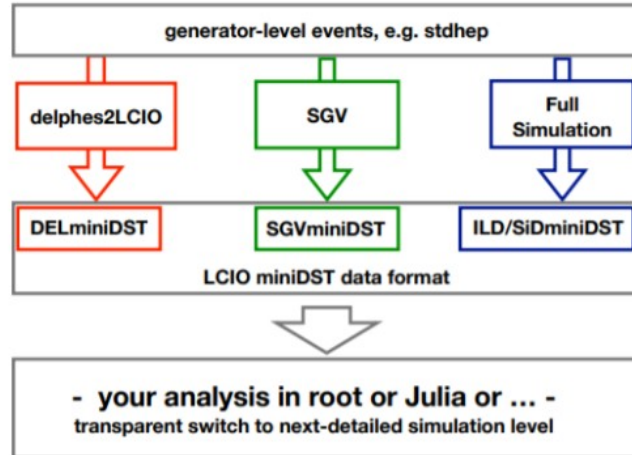


- “dead space free” granular calorimeters put **tight demands on compactness**
- Current developments within **CALICE meet these requirements**
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ILD has done a lot on the software and reconstruction side:

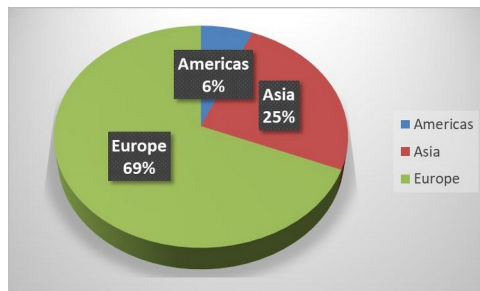
- ▶ We are a central player in pushing community wide software solutions in particular with iLCSOft (LCIO, DD4hep, etc) developed over 15 years
- ▶ We are collaborating with other communities (linear, circular, FCC-hh) to modernize our software stack: **key4hep** (DD4hep, EDM4hep,...)

Accessing ILD simulated data



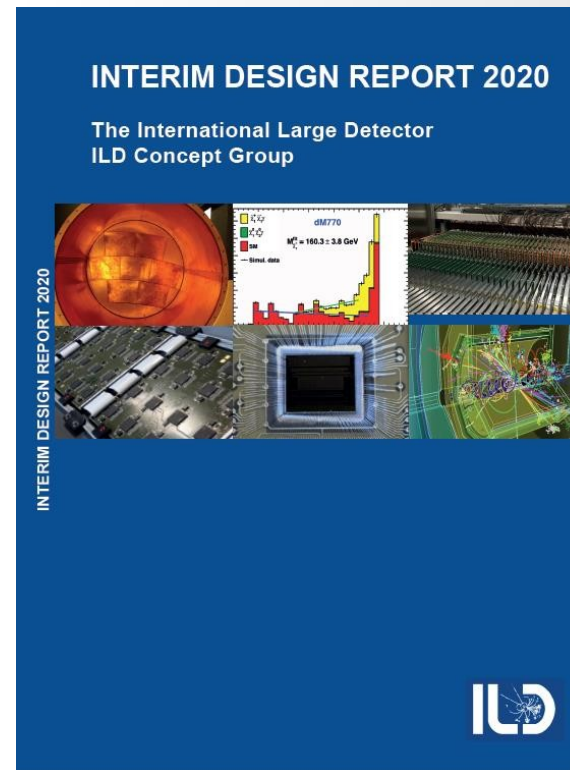
The ILD status: Interim Design Report

The work of ILD over the last years has been documented in the IDR and published this year. Signed by 302 authors from 62 institutes



What promising direction of R&D do we see to further improve ILD

- Timing
- Forward
- ..
- Technology scouting



<https://arxiv.org/abs/2003.01116>

Very exciting moment to join ILD

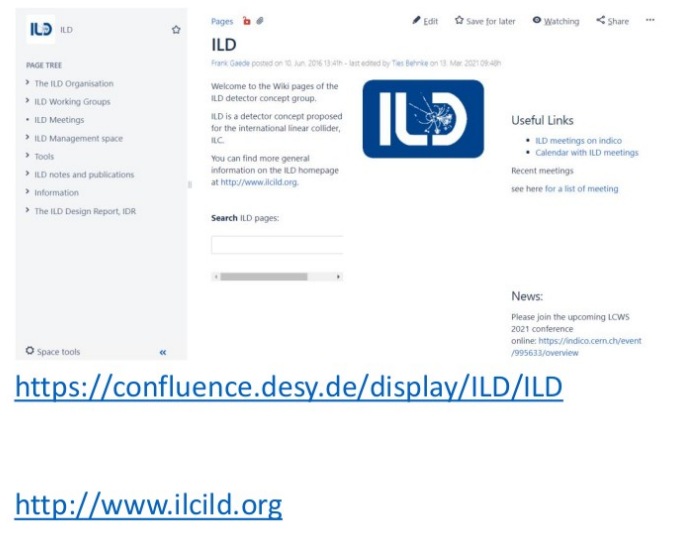
Joining ILD

We welcome new members

- No resource commitments needed
- Key contributions are possible in many areas
- Full participation in the shaping of the ILD program and future

Guest membership

- Very simple access mechanism
- Access to ILD simulated data and tools
- Great to do a study or a feasibility study in the ILD context
- Limited duration



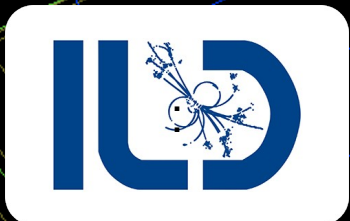
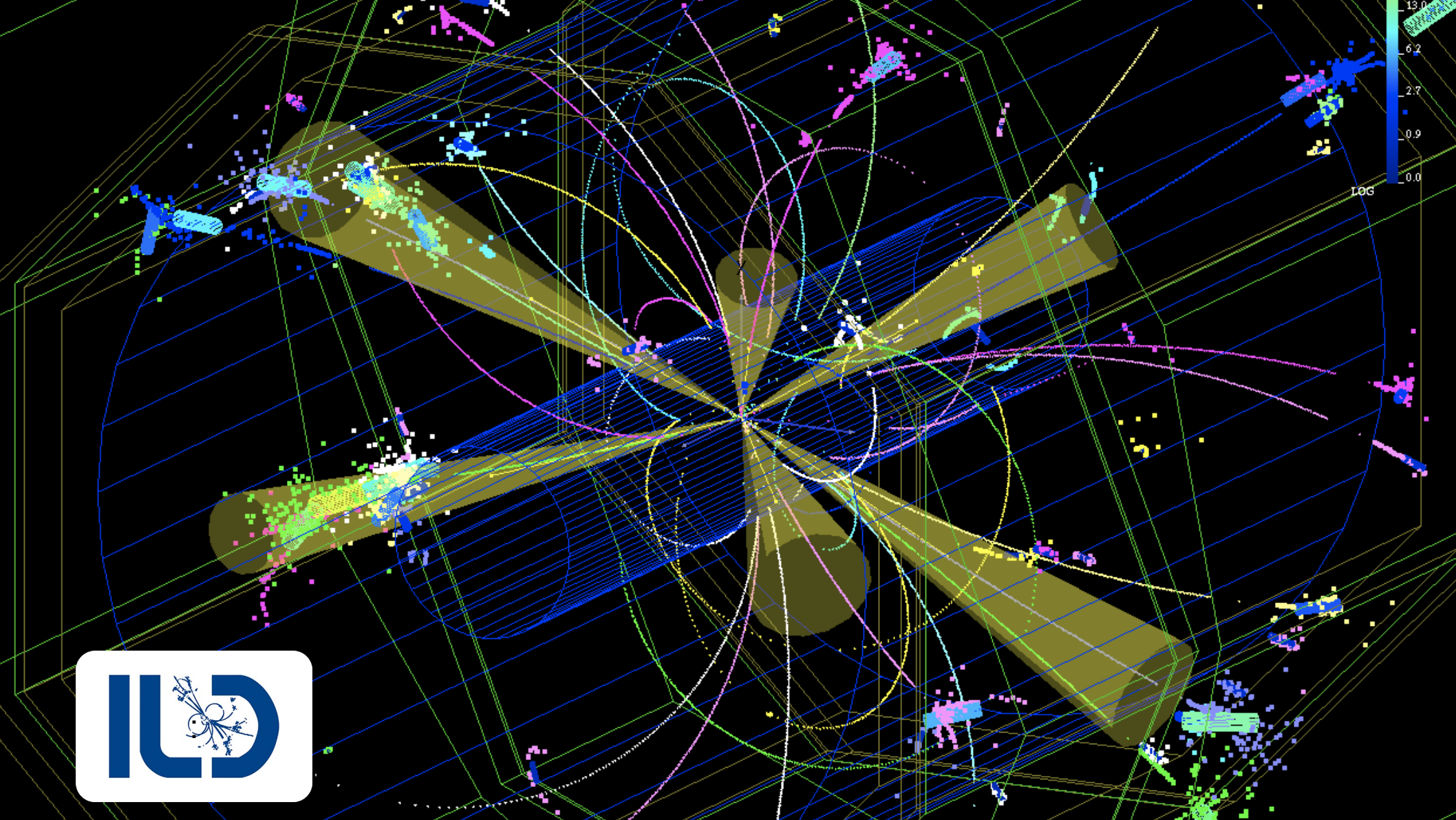
The screenshot shows the ILD Confluence page. On the left is a 'PAGE TREE' with links to 'The ILD Organisation', 'ILD Working Groups', 'ILD Meetings', 'ILD Management space', 'Tools', 'ILD notes and publications', 'Information', and 'The ILD Design Report, IDR'. The main content area has a 'Welcome to the Wiki pages of the ILD detector concept group.' message, a 'Search ILD pages:' search bar, and a 'News:' section with a link to the '2021 conference'. On the right, there are 'Useful Links' for 'ILD meetings on indico' and 'Calendar with ILD meetings', and 'Recent meetings'.

<https://confluence.desy.de/display/ILD/ILD>

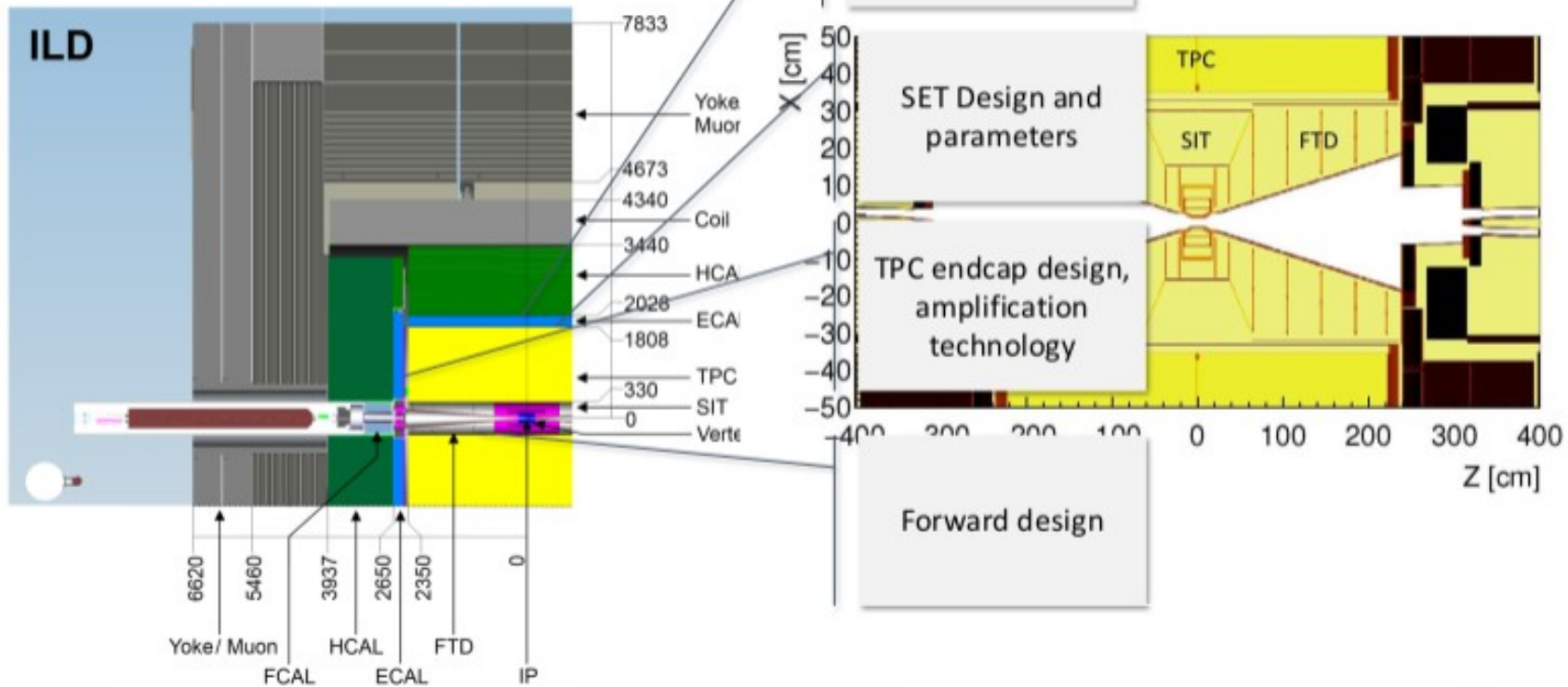
<http://www.ilcild.org>

Slide borrowed from T. Behnke (ILD spokesperson)





Opportunities in ILD



ILD as an organisation

ILD executive team (2021-2023)

Ties Behnke



Kiyotomo Kawagoe

Technical working group



Mary-Cruz Fouz, Karsten Buesser

Software working group



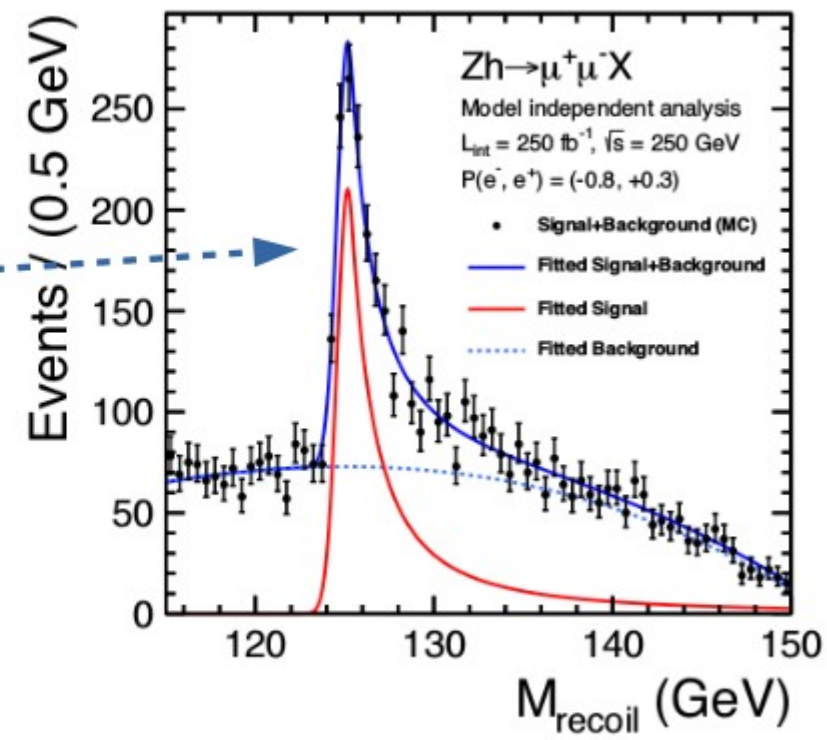
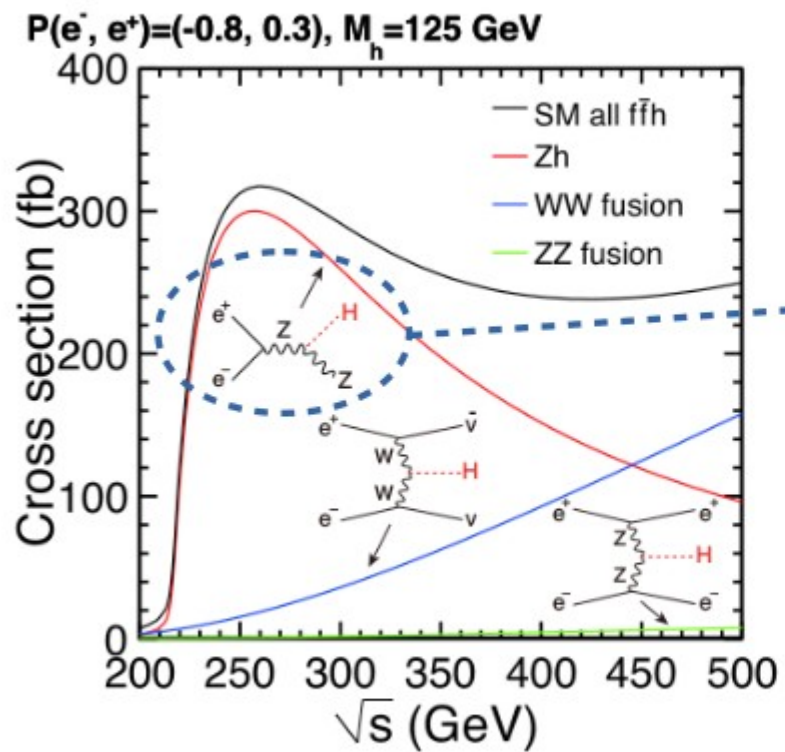
Frank Gaede, Daniel Jeans

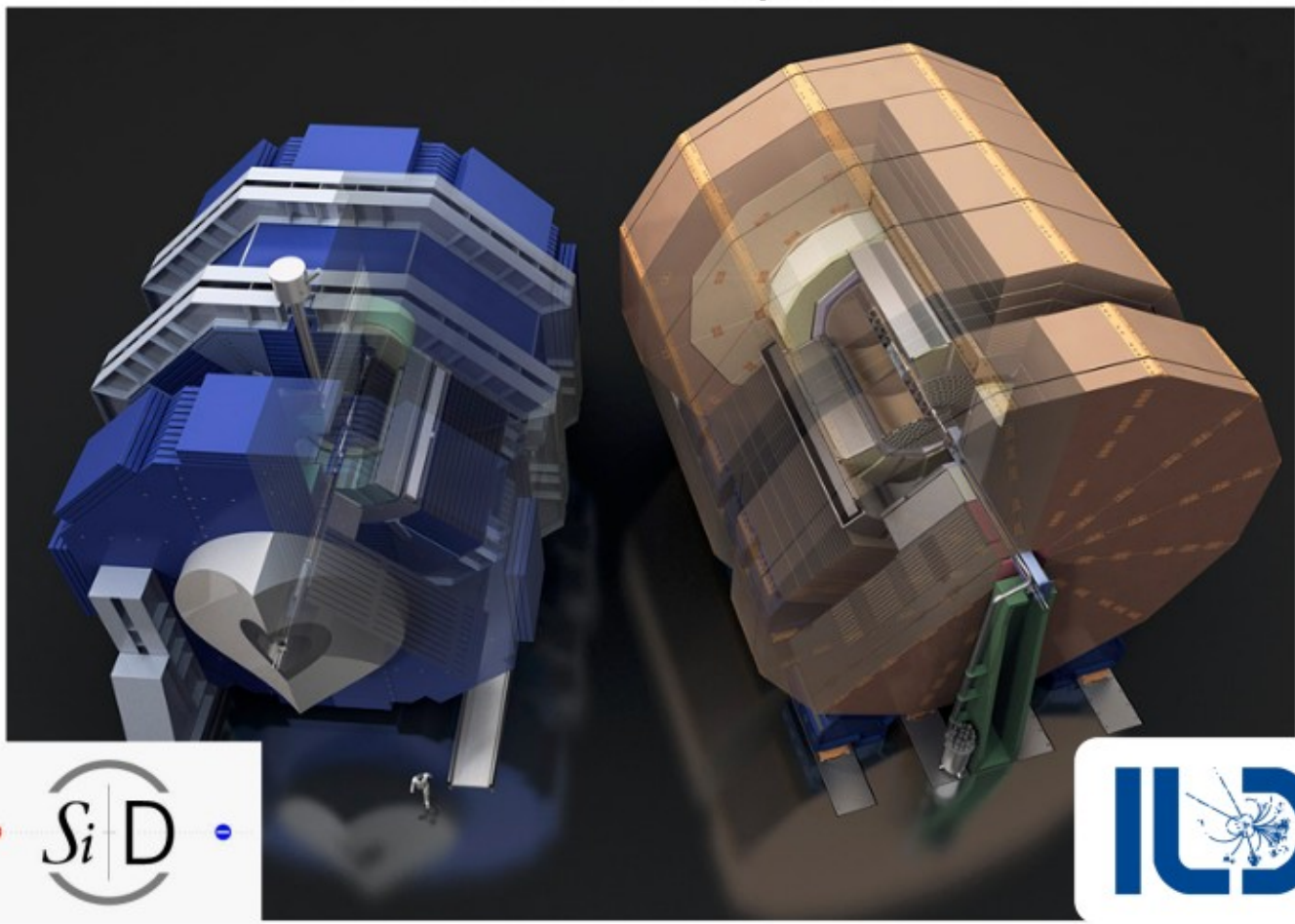
Physics working group



Keisuke Fujii, Filip Zarnecki

+ four elected members from the ILD community. Elections for these positions are in progress.





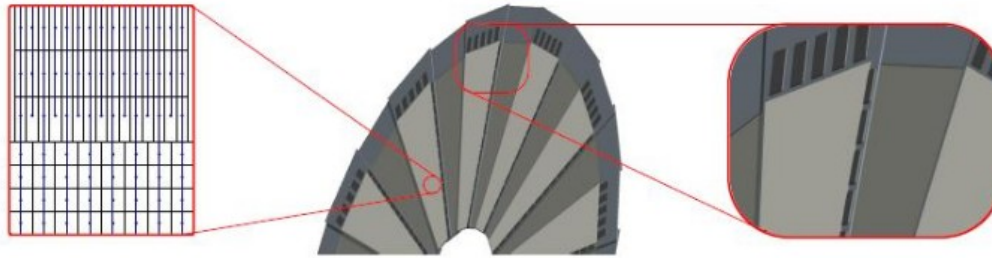
reynori



single Interaction Point, shared by 2 detectors: "push-pull"



Technologies for pixelated FTD 1 & 2



-All technology options remain open

CMOS

FPCCD

DEPFET

3D-integrated

SOI

...

-Conceptual adaption of barrel design to disk geometry for some technologies, but no fully engineered design

-This talk: develop a realistic prototype (mock-up) and simulation

-Assess thermo-mechanical performance

Most studies for inner disks FTD 1&2 were inspired by DEPFET vertex detector developments for ILC and Belle II

Incorporate new developments:

- IFIC activity in CMOS for Belle II PXD upgrade
- advent of LGAD sensors

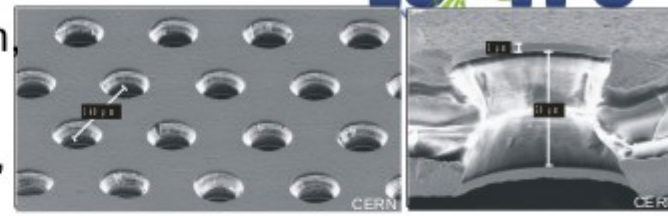


Three Baseline Technologies

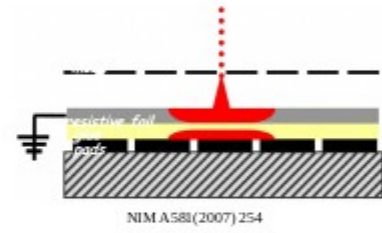


GEMs: copper-insulator- copper sandwich with holes

- 2 configurations are being tested:
- triple GEMs with 'standard CERN GEMs'
 - double GEMs with 100 μ m LCP insulator



Resistive Micromegas: Bulk-Micromegas with 128 μ m gap size between mesh and resistive layer



- GridPix:** Micromegas with 1 μ m Al-grid over Pixel readout ASIC
- 55 μ m pitch of readout pixels
 - resistive layer needed for protection of ASIC

